

Laser Drilling System for PCB

Manufacturing Equipment

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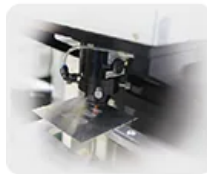


- CO2/UV Laser drilling with R2R system
- Laser drilling specialized for PCB

Description

Features

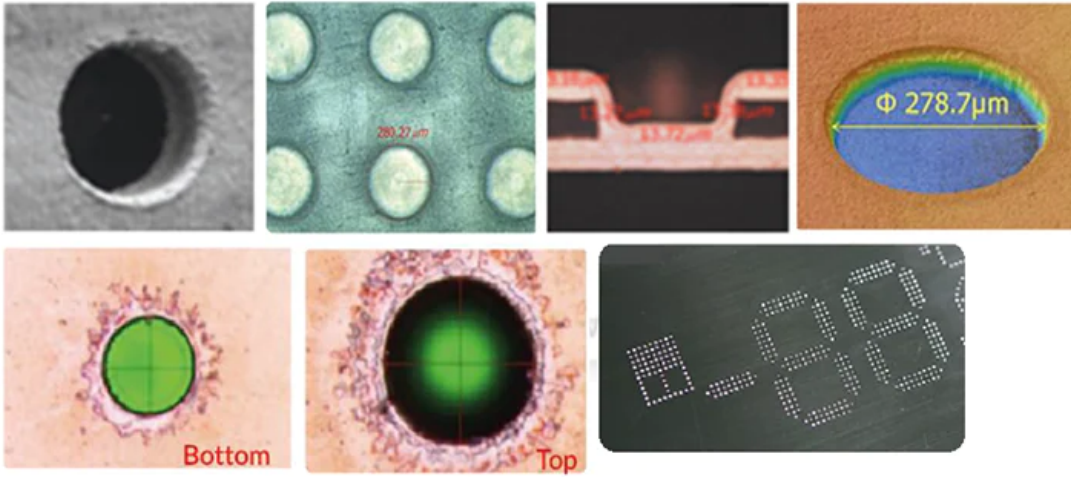
- High speed and High precision processing
- CO2, UV, Green Laser head equipped



Processing target

PCB, Metal, OLED film, Stip, Panel, Silicon Board, Glass Board etc.

Example of Process



	60μm	100μm	200μm	400μm
Top	 67μm	 107μm	 206μm	 394μm
Bottom	 62μm	 96μm	 198μm	 375μm

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